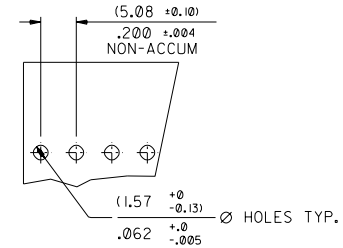


- NOTES:
1. DIMENSIONS SHOWN ARE (MM)/IN.
 2. PIN PUSH OUT FORCE 3lbs MIN
 3. RELATIVE HEIGHT OF PINS MUST NOT VARY MORE THAN .005 T.I.R
 4. PIN SOLDERABILITY PER MOLEX ENG STD NO. I52
 5. CODE LETTER PRECEDING PART NO. DESIGNATES MANUFACTURE LOCATION, i.e. I = IRELAND



RECOMMENDED P.C. BOARD HOLE DIMENSIONS

3008-N *-*

BASE NO. _____ NO. OF CCTS _____

VOID LOCATION
 1 - CCT NO. 1
 2 - CCT NO. 2
 5I- MULTIPLE VOIDS

VERSION
 A - FIRST VERSION
 B - SECOND VERSION
 VERSION FOLLOWED BY C - GOLD

4	Z
3	Z
2	Z
1	Z

REDRAWN ON CAD EC NO. E90108 DRWN: AOD 98/09/11 CHK: / / / APPR: / / / Z	QUALITY SYMBOLS MAJOR CRITICAL C=	GENERAL TOLERANCES: (UNLESS SPECIFIED)		SCALE 4 : 1	DESIGN UNITS <input type="checkbox"/> mm <input checked="" type="checkbox"/> INCH	<input checked="" type="checkbox"/> THIRD ANGLE <input type="checkbox"/> PROJECTION	DIMENSIONS: <input type="checkbox"/> mm <input checked="" type="checkbox"/> INCH <input type="checkbox"/> mm ONLY	SHT REV	
		4 PLACES ±0. ±. 3 PLACES ±0. ±.010 2 PLACES ±0.25 ±.016 1 PLACE ±0.41 ±.	DRAWN BY & DATE AADONOVA 98/09/11 CHECKED BY & DATE MGOONEY 98/09/11 APPROVED BY & DATE MWILHITE 98/09/11	TITLE: WAFER FLAT, KK (5.08)/.2 CENTRES FOR (1.14)/.045 SQ PINS		MOLEX INCORPORATED		MATERIAL NO. SEE CHART SDAE-3008-N*-*	DRAWING NO. SDAE-3008-N*-*
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.							SIZE C

PART NO.
 DWG NO.
 SDAE-3008-N*-*

